M62021L,P,FP

SYSTEM RESET IC WITH SWITCH FOR MEMORY BACK-UP

DESCRIPTION

The M62021 is a system IC that controls the memory backup function of SRAM and microcomputer (internal RAM). The IC outputs reset signals(RES/RES) to a microcomputer

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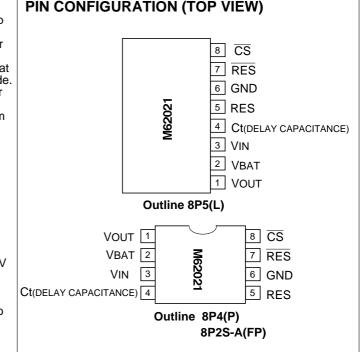
The M62021 contains in a single chip, power supply monitor and RAM backup functions needed for a microcomputer system, so that the IC makes it possible to construct a system easily and with fewer components compared with a conventional case that uses individual ICs and discrete components.

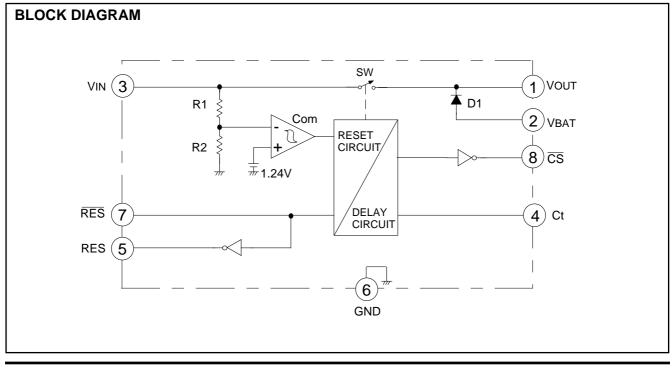
FEATURES

- •Built-in switch for selection between main power supply and backup power supply to RAM.
- •Small difference between input and output voltage (Iout=80mA,VIN=5V)0.2V typ
- •Detection voltage (power <u>supply</u> monitor voltage)4.40V±0.2V •Chip select signal output(CS)
- Two channels of reset outputs(RES/RES)
- •Power on reset circuit built-in
- •Delay time variable by an external capacitance connected to Ct pin
- •Facilitates to form backup function with a few number of components

APPLICATION

Power supply control systems for memory backup of microcomputer system and SRAM boards with built-in backup function that require switching between external power supply and battery.







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ABSOLUTE MAXIMUM RATINGS(Ta=25°C, unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
Vin	Input voltage		7	V
Ιουτ	Output current		100	mA
Pd	Power dissipation		800(SIP)/625(DIP)/440(FP)	mW
Ke	Thermal derating	(Ta 25°C)	8(SIP)/6.25(DIP)/4.4(FP)	mW/°C
Topr	Operating temperature		-20 ~ +75	°C
Tstg	Storage temperature		-40 ~ +125	°C

ELECTRICAL CHARACTERISTICS(Ta=25°C, unless otherwise noted)

Symbol					Unit		
Symbol Parameter		Test conditions		Min.	Тур.	Max.	Unit
Vs	Detection voltage	VIN(At the change from H →L)		4.2	4.4	4.6	V
Vs	Hysteresis voltage	Vs=VsH-VsL		50	100	200	mV
Vs/ T	Temperature coefficient of detection voltage				0.005		%/°C
lcc	Circuit current	Iout=0mA	VIN=4V		2.0	4.0	mA
			VIN=5V		7.5	12.0	IIIA
Vaaaa	Difference between input and output voltage		Iout=50mA		0.125	0.25	V
Vdrop	Difference between input and output voltage	Vin=5V	IOUT=80mA		0.2	0.4	
Voh(Ct)	Ct output voltage (high level)	VIN=5V(Note1)		4.5	5.0		V
Vol(Ct)	Ct output voltage (low level)	VIN=4V(Note1)			0.02	0.1	V
Voh(RES)	RES output voltage (high level)	VIN=4V(Note1)		3.5	4.0		V
	RES output voltage (low level)		(Note1)		0.02		V
Vol(RES)		Vin=5V	ISINK=1mA		0.05	0.2	
Voh(RES)	RES output voltage (high level)	VIN=5V(Note1)		4.5	5.0		V
	RES output voltage (low level)		(Note1)		0.02		
VOL(RES)		VIN=4V	ISINK=1mA		0.05	0.2	V
, <u>,</u>		VIN=4V (Note2) VIN=0V,VBAT=3V (Note2)		3.50	3.57		V
Voh(CS)	CS output voltage (high level)			2.40	2.47		v
	CS output voltage (low level)	N/ EV/	(Note1)		0.08		V
Vol(CS)		Vin=5V	ISINK=1mA		0.1	0.3	V
1-	Backup Di leak current	Vbat=3V	VIN=5V			±0.5	
lr		VBAT=3V	VIN=0V			±0.5	μA
VF	Backup Di forward direction voltage	IF=10µA		0.54	0.6	V	
tpd	Delay time	VIN=0V → 5V,Ct=4.7µF		10	27	55	ms
td	Response time	VIN=5V → 4V			5.0	25.0	μs
VOPL(RES)	RES limit voltage of operation	(Note 3)			0.65		V

Note 1.Regarding conditions to measure Vo⊢ and Vo∟voltage values are to be generated by internal resistance only and no external resistor is used. 2.These values are produced inserting an external resistor,RCS=1M ,between the CS pin and GND. 3.With no external resistor (10k internal resistance only)



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TEST CIRCUIT Vm2 M62021 VIN SW6 SW2 10 VOUT 2 A 3 1 SW7

 R1 <u>3</u> D1 lm1 Vm SW1 01 VBAT SW5 4 2 9 2 Com SW4 <u>5</u> ₹R2 RESET CIRCUIT 11 10 ĆRŤ <u>6</u> TIF1 /m3 8 <u></u> 一 一 1.24V $\frac{1}{m}$ RES DELAY (7 CIRCUIT Ct 4 RE<u>S</u> 5 $\frac{1}{2}$ 6 GND Sw3 ⊈ ≠⊈ 4.7μ

SWITCH MATRIX

Symbol Parameter		V1	1 V2 IF1 IF	IF2		S W					Measuring		
Cymbol	i alameter		V 2		IFZ	1	2	3	4	5	6	7	instrument
Icc	Circuit current	4V 5V	—	-	—	1	ON	OFF	1	OFF	1	1	lm1
Vs (VsL)	Detection voltage Vout (VIN negative-going) Ct RES RES	Decrease from 5V		_	_	1	ON	OFF	1	OFF	2 3 4 5 6	1	(Note5) Vm4 CRT Vm1
VDROP	Difference between input and output voltage	5V	—	-50mA -80mA	_	1	ON	OFF	1	OFF	2	2	Vm2
VOH(Ct) VOL(Ct)	Ct output voltage(high level) Ct output voltage(low level)		_	—	_	1	ON	OFF	1	OFF	4	1	Vm4
VOH(RES) VOL(RES)	RES output voltage(high level) RES output voltage(low level)	4V 5V	_		. —	1	ON	OFF	1	OFF	5	1	Vm4
Voh(RES) Vol(RES)	RES output voltage(high level) RES output voltage(low level)	5V 4V	_	1mA	_	1	ON	OFF	1	OFF	6	1	Vm4
Voh(CS)	CS output voltage(high level)(Note 4)	4V 0V	3V		_	1	ON	OFF	1	OFF	3	1	Vm4
Vol(CS)	CS output voltage(low level)	5V	_	1mA								2	-
IR	Backup Di leak current	5V 0V	3V	_	_	1	ON	OFF	2	OFF	1	1	lm2
VF	Backup Di forward direction voltage	0V	_	-	10µA	1	ON	OFF	3	ON	1	1	Vm3
tpd td	Delay time Response time RES RES			_	_	2 (Note6)	ON	ON (Note7)	1	OFF	2 3 5 6	1	CRT

Notes 4.To measure VoH(CS), insert a 1M resistor between the CS pin and GND. 5. While monitoring each output by Vm4 or CRT, measure the input voltage Vm1 when the output goes from H to L and L to H.Regarding VsH, raise Vin from 4V and measure the input voltage Vm1 when the output goes from H to L and L to H. Vs is VsH-VsL.

6. To measure delay time, change VIN from 0V to 5V and compare, with respect to each pin, the positive-going edge observed on a monitor with that of VIN. To measure response time, change VIN from 5V to 4V and compare, with respect to each pin, the negative-going edge observed on a monitor with that of VIN.

7.Set the switch to OFF when measuring response time.



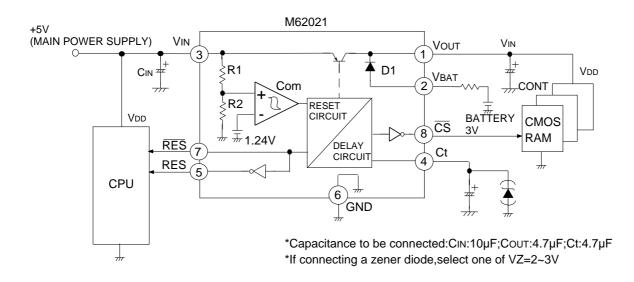
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EXPLANATION OF TERMINALS

Pin No.	Symbol	Name	Function			
1	Vout	Power supply output	VIN and VBAT are controlled by means of an internal switch and output through Vout The pin is capable of outputting up to 100mA.Use it as VDD of CMOS RAM and the like			
2	VBAT	Backup power supply input	Backup power supply is connected to this pin If a lithium battery is used,insert a resistor in series for safety purposes			
3	Vin	Power supply input	+5V input pin.Connect to a logic power supply.			
4	Ct	Delay capacitor connection pin	A delay capacitor is connected to this pin.By connecting a capacitor, it is possible to delay each output			
5	RES	Positive reset output	Connect to the positive reset input of a microcomputer. The pin is capable of flowing 1mA sink current			
6	GND	Ground	Reference for all signals			
7	RES	Negative reset output	Connect to the negative reset input of a microcomputer. The pin is capable of flowing 1mA sink current			
8	CS	Chip select output	Connect to the chip select of RAM.The CS output is at low level in normal state thereby letting RAM be active.Under failure or backup condition,the CS output is set to high level,then RAM enters standby state disabling read/write function.The pin is capable of flowing a 1mA sink current			

APPLICATION EXAMPLE





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CONFIGURATION

<Power supply detector>

The internal reference voltage Vref is compared by means of a comparator with resistor-divided voltage VR(resistor-divided voltage produced by R1 and R2 from VIN).

If the input voltage is 5V,VR is set to 1.24V or higher,so the comparator output is at low level and the Ct output(Q1 collector output) is set to high level. If the input voltage drops to below 4.4V in an abnormal condition,VR becomes below 1.24V,so the comparator output goes from low to high level and the Ct output,from high to low. The input voltage at this point is called VSL.Next,when the input voltage,restored from abnormal state,has a rise,the comparator output goes from high.

The comparator used for detection has 100mV hysteresis(Vs),so that malfunctioning is prevented in case that the input voltage slowly drops or VR nearly equals Vref.

<Delay Circuit>

Connecting an external capacitor to the Ct pin lets RES,RES,CS,and VOUT be delayed due to RC transient phenomenon(electric charge). Delay time is determined as follows.

Delay time(tpd)= Ct X (R3 + R4) X In $\frac{[VOH(Ct)-VOL(Ct)]}{[VOH(Ct)-INV1(VTH)]}$ =Ct X 22k X 0.2614

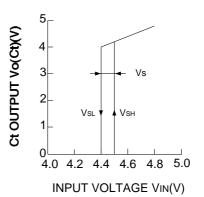
=5.75 X 10³ X Ct

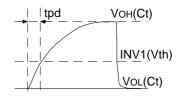
Taking into consideration the time taken by the oscillator of microcomputer to be stable, connect a 4.7μ F capacitor to the Ct pin.

(As the response time of detection can be slowed due to internal structure depending on the rising rate of power supply, avoid connecting a too large capacitance.

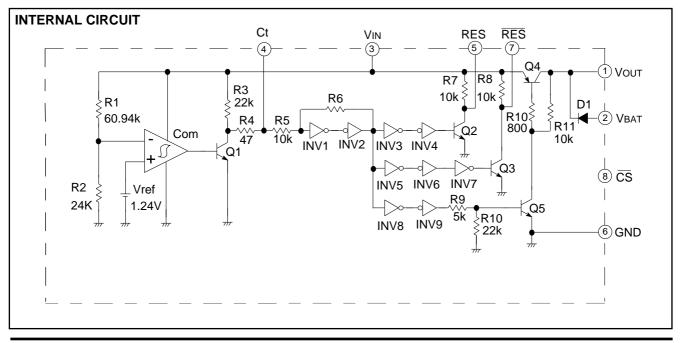
<Schmitt trigger circuit>

Since waveforms show a gentle rise due to the RC delay circuit,INV1,INV2,R5,and R6 constitute a schmitt trigger circuit to produce hysteresis so as to prevent each output from chattering.





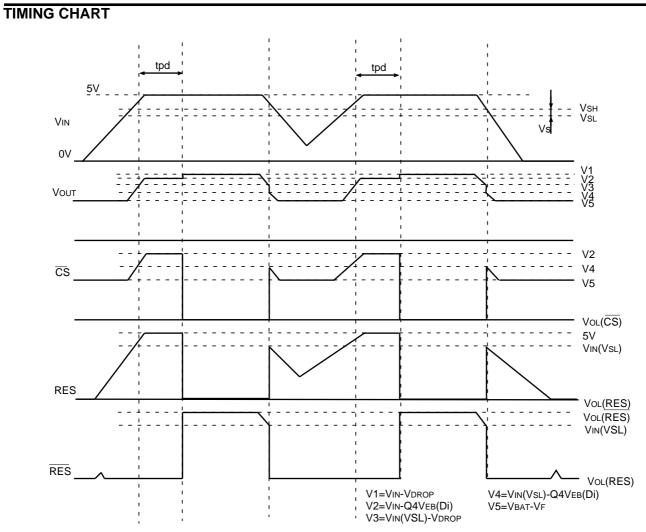
DELAYED OUTPUT WAVEFORMS OF Ct



*Ct is an external capacitance.



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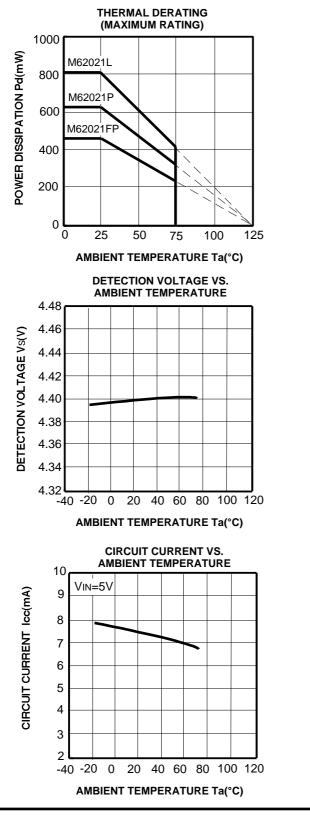


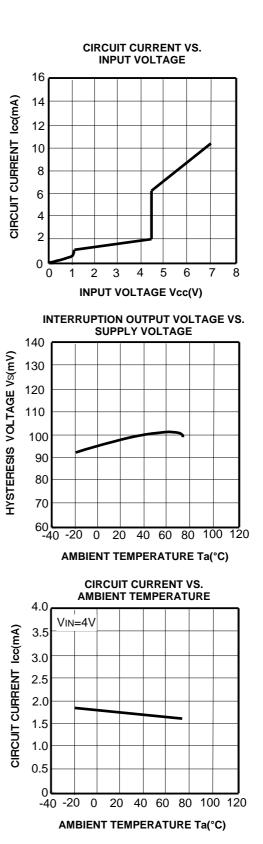
Input voltage	In normal operation	In failure(instantaneous drop)	Restoration from failure (instantaneous drop)	In backup state		
Output	Input voltage:5V	Input voltage:5V → 4V Each output varies if the input voltage drops to Vs∟ or under	Input voltage:4V→5V If the input voltage goes higher than VSL by 100mV,each out-put varies after delay produced by the delay circuit	Input voltage:0V Backup voltage:3V		
VOUT	With Q4 set to ON, a voltage (VIN-VDROP)is output	Q4 is turned OFF.A voltage (VIN-Q4 VEB(Di) is output by the diode between E and B of Q4	Q4 is turned ON after delay and a voltage(VIN-VDROP) is output	VBAT-VF		
RES	The <u>output</u> level is VoL(RES) with a logic low	As the state shifts from a logic low to logic high,the output level becomes approximately equal to the input voltage	A logic high is maintained,and than shifts to a logic high			
RES	The o <u>utput</u> level is Voн(RES) with a logic low	As the state shifts from a logic high to logic low,the output level becomes VoL(RES)	A logic low is held,and than shifts to a logic high			
CS	The output level is $V_{OL}(\overline{CS})$ with a logic low	As the state shifts from a logic low to logic high,the output level becomes the voltage VIN- Q4EB(Di).	A logic high is maintained,and than shifts to a logic high	The output is a logic high and the output level is VBAT-VF		



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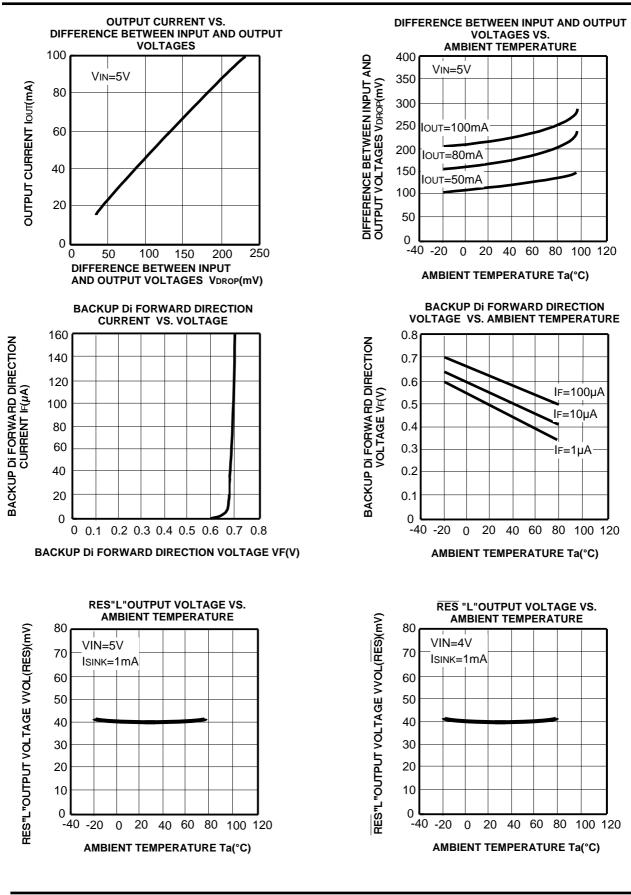
TYPICAL CHARACTERISTICS





MITSUBISHI<Dig.Ana.INTERFACE> M62021L,P,FP

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